

MEMS at ESA



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- ***Main types of MEMS addressed for Space applications:***
 - RF MEMS
 - Inertial MEMS for AOCS
 - MEMS for propulsion systems
 - MOEMS

- ***Generic supporting activities include:***
 - Reliability and failure modes studies
 - Radiation effects
 - Packaging and integration approach
 - Methodology for Space validation

- ***What's next?***
 - MNT in ESA TRP Work Plan 2008-2010
 - NEOMEx Strawman Mission

RF MEMS

➤ **RF MEMS switches and switching matrices (TRL 3/4)**

○ Advantages:

- Low insertion loss, high isolation, high linearity, low consumption
- Integration with planar interconnect on a microwave substrate (higher integration and reduced losses)

○ Space applications:

- Reconfiguration, redundancy and routing in RF equipments
- Phased array and reflect array antennas

➤ **Main ESA partners:**

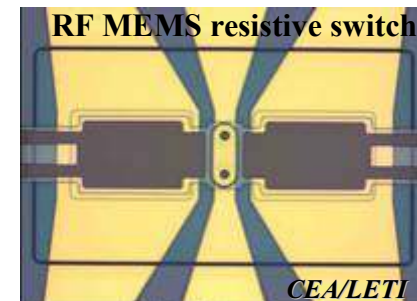
- TAS-F, CEA/LETI (F), LAAS & NKUA (Athens Univ.)
- TAS-F & XLim (F)
- TAS-I & FBK (I)

➤ **Present ESA activities include:**

- Several switch technology development
- Proof-of-concept demonstrator of a switching matrix

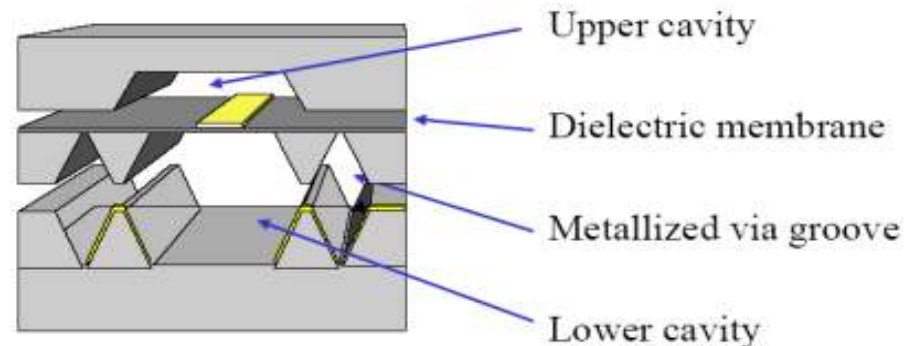
➤ **Performance has been demonstrated. The major concern is still the reliability**

- Longest lifetime obtained with the dielectric-less capacitive switch from XLim.
- New study on the characterisation and the avoidance of dielectric charge trapping
- On-going study on sensitivity to radiation of electrostatic RF MEMS switch



➤ *RF micro-machined planar filters* (TRL 4)

- Description: Resonators on a membrane into a shielded cavity
- Application: telecom satellite repeaters in the Ka (27-40 GHz) and Q/V (40-50 GHz)
- Merge advantages of both standard planar filter and waveguide filter technologies:
 - Miniaturization
 - Batch fabrication (Potential cost reduction)
 - High quality factor in the Ka and Q/V bands (up to 800 at 30 GHz).
- Initially developed by an academic laboratory (**XLim, F**)
- **Successfully transferred to an industrial small volume production (Reinhardt Microtech AG, CH).**
- Status: On-going **Space evaluation and industrial qualification** (RMT and TAS-F)



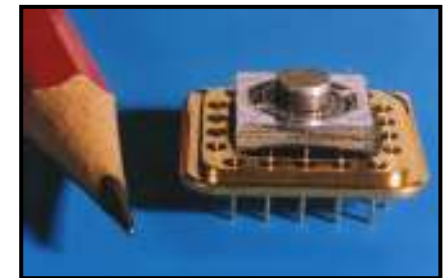
Inertial MEMS

➤ **MEMS gyrometer for satellites (TRL 5)**

- Developed by **Atlantic Inertial Systems** (former BAe), **SEA** and **SELEX**.
- **Spin-in** from original automotive application
- Moderate performance ($\sim 5^\circ/\text{h}$), low-cost sensors, complementing star sensors for:
 - Rate determination, failure detection & rate damping
- **Flight Model was delivered for technology demonstration on Cryosat 2**
- **Sentinel-3** is foreseen as another flight opportunity
 - **EQM qualification** is now starting

➤ **MEMS sensors spin-in process is rather complex:**

- Need to re-design read-out and commands electronics
- Require Rad-Hard IEEE parts



➤ **The MEMS itself account for a few % of the total gyrometer mass (770g).**

- Mass and volume are mainly driven by the box and the electronic PCB

- ***MEMS accelerometer for satellites IMU (Inertial Measurement Unit) (TRL2)***
 - **System study for an IMU** (finishing soon)
 - Performed by **TAS-F** (with MEMSCAP and SEA)
 - Definition of the specification for an accelerometer
 - Survey of existing accelerometers and gyrometers for use in an IMU
 - Follow-on in 2009: **Accelerometer for IMU demonstrator** (TRP, open-competition)

- ***MEMS accelerometer for launchers (TRL 2)***
 - **Theon Sensors** (with EADS Astrium ST and X-Fab)
 - Finished in 2008: feasibility study for a MEMS accelerometer
 - Design and simulations of the MEMS with the read-out electronics
 - Follow-on in 2009: Development and characterisation of the MEMS and the electronics.

- ***MEMS-based IMU for planetary rovers*** (TRL 1/2)
 - **Mass and volume constrained application**
 - Specific environmental conditions
 - Starting: Feasibility study on the integration of the MEMS gyro and the MEMS accelerometer with the electronics in a single package.

Optical MEMS

➤ **Optical switch and switch matrices for telecom payload (TRL 3)**

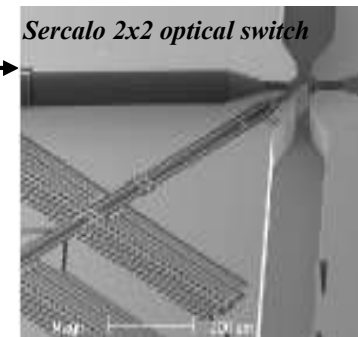
- Advantages: Flexible, Low loss, High isolation between channels, Low power consumption
- Applications: optical cross-connection of μ -wave signals
optical generation & distribution of high-frequency LO's
optical frequency mixing and down-conversion

➤ **Development of a large order *optical switch matrix* size for reconfigurable repeater and interconnects**

- Developed by **Sercalo** (CH), with IMT, EPFL and TAS-F
- Status: Manufacturing a proof-of-concept demonstrator

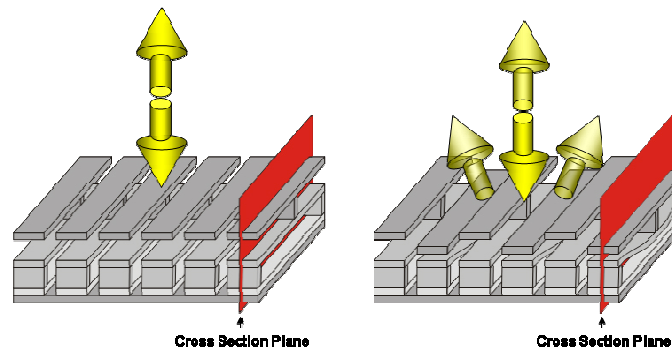
➤ **Evaluation of commercially available MOEMS**

- Low port count optical switch from **Sercalo** (CH)
- **Variable optical attenuator** from **MEMSCAP** (F)
- They appear sufficiently robust for space application, but Rad-Hard electronic is required
- Drafting of methodology for MOEMS space qualification



➤ **Programmable Micro-Diffraction Gratings (PMDG) for Spectroscopy** (TRL 3)

- Description: Array of micromechanical phase gratings (one per pixel) providing controlled diffraction of incident light.
- **Investigations on devices commercially available**
 - The optical and electrical properties of Polychromix, Silicon Light Machines devices were characterised.
- **Identification spectrometer concepts using PMDG**
 - Pros: Flexibility, which could speed-up search for specific spectral responses
 - Cons: Limited to non-imaging applications
 - Potential application: Spectral analysis for Exoplanet search or for planetary exploration
- Status: **Design and prototyping of a European PMDG device**
Performed by **CSEM** (CH)



➤ **Evaluation of a Digital Micro Mirror Arrays (DMMA) for Multi-Object Spectrometers**

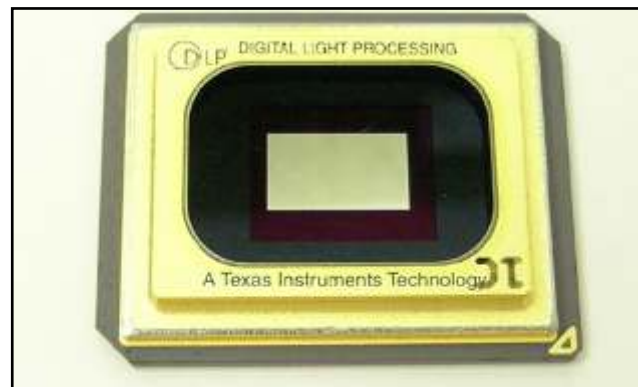
○ Description:

- **Arrays of miniature tiltable mirrors**, where each individual mirror correspond to one pixel in a pattern.
- High resolution, high contrast ratio

○ Application: flexible **selection of objects in the field of view** of a spectrometer

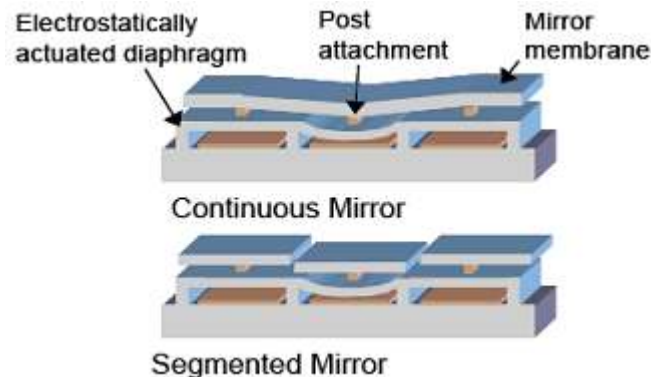
○ **Investigations of commercial DMMA in preparation to Euclid mission**

- Performed by **Visitech** (Norway) and **LAM** (France)
- **Texas Instrument's DMD** is the only available device with 2MPixels
- Evaluation of the DMD device against mission requirements
- Will serve as a Go/No Go for further development of the Euclid mission.



➤ **MOEMS Deformable Membrane Mirrors (DMMs) for Adaptive Optics (TRL 2/3)**

- **Description:** **Light wavefront correction** by dynamic deformation of the mirror surface, either with a continuous or segmented membrane.
- **Applications:** Wavefront correction in **large science telescopes, optical telecommunications** (space-ground links, intersatellite links), and for high power laser beam shaping (e.g. for **LIDARs**).
- Under a past ESA study, Astrium has investigated:
 - TU Delft **continuous mirror**: suitable for low-spatial frequency correction
 - Fraunhofer IPMS **segmented mirror array**: suitable for high spatial frequency correction
- No follow-on ESA activity for a few years. A **new development activity** is now in the GSTP work plan on “**Adaptive Deformable Mirrors**”, but it will only be implemented after confirmation of financial support from a national delegation. (Not restricted to MEMS)



MEMS for propulsion

➤ **MEMS-based cold-gas thrusters for micropropulsion (TRL 4)**

- Development performed by **Nanospace AB** (Sweden)
 - Description:
 - Pod with MEMS thrusters, proportional flow control valve, filter and gas heater
 - MEMS isolation valve, MEMS pressure relief valve
 - Performance:
 - Thrust: 10 μ N to 1 mN
 - Specific impulse: 50-100 s for nitrogen propellant
 - In-flight demonstration: PRISMA formation flying satellite (SNSB)
 - Status: **Starting on-ground experimental evaluation of the performance**
- **Miniaturisation of the thruster pod** (mass < 115 g, diameter < 5 cm) thanks to:
- Stacking of silicon wafers
 - Single mechanical housing for several functions



➤ **MEMS-based Xenon fluid handling systems for electric propulsion (TRL 3)**

- Developed by **Nanospace AB** (Sweden)
- MEMS-based Xenon feed system including filters, isolation valves, flow control valves, thermal flow restrictors.
- The system is placed between the tank and the engine to control the propellant flow.

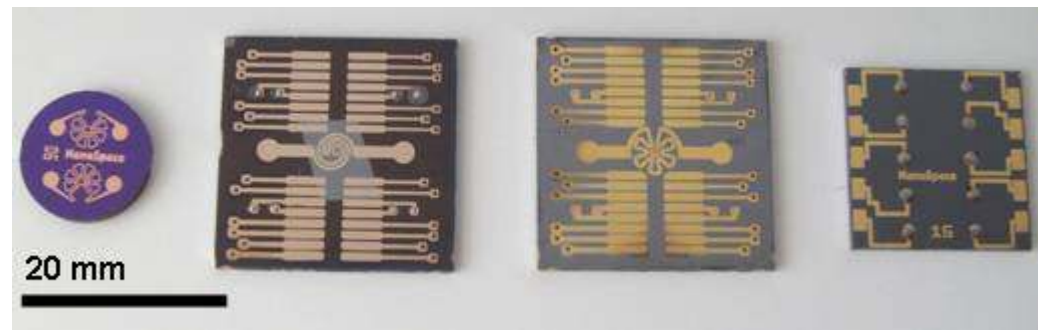
➤ **Miniaturisation** to a mass < 200 g thanks to:

- Stacking of silicon wafers
- Single mechanical housing for several functions

➤ **Status:** Proof-of-concept demonstrated.

Now prototyping and functional testing for application in a mini-ion engines

➤ **Stand-alone components** were also developed (e.g. MEMS isolation valve)



- **Pressure sensor for tanks/lines of propulsion systems (TRL 4)**
 - Developed by **Presens** (Norway)
 - **Spin-in** from the oil and gas industry.
 - Up to 250 bars; Accuracy better than 0.1%.
 - Housing compatible with high-pressure and aggressive fluids.
 - A flight model was procured for PRISMA satellite
 - Follow-on activity in 2009/2010:
 - Consolidation of the design for Space (e.g. rad-hard electronics)
 - Evaluation testing
 - A low-pressure MEMS-based sensor is also in development.
- **Miniaturisation is limited by the housing, the electronics and the connection.**



PRESENS sensor assembled to PRISMA spacecraft



MEMS piezoresistive sensing element

Generic supporting activities

➤ Reliability and failure modes of MEMS

○ MEMSRAD study on the effect of Space radiation on MEMS

- On-going with **EADS-ST**, TAS-F & Infoduc
- Drafting MEMS radiation testing guidelines
- Test on hardware samples (RF MEMS switch and MEMS accelerometer), including TID, SEE and Displacement damage.

○ Avoidance of MEMS dielectric charge trapping

- Starting in January 2009
- Defining methods for the characterisation of dielectric charge trapping
- Investigating new technological solutions

➤ MOEMS Space validation methodology

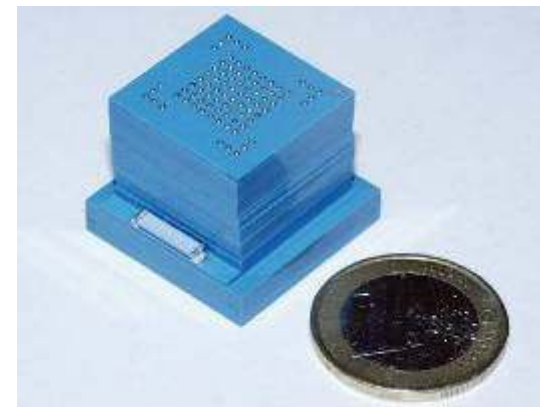
- Finished in 2007. Performed by **Thales Alenia Space**.
- A qualification methodology for optical-MEMS was developed and applied to two candidate devices (an optical switch and a variable optical attenuator).

➤ Packaging and integration

- **WALES (WAFER level encapsulation for micro-systems): intended TRP study**
 - Development of wafer level packaging techniques for RF MEMS and non-RF MEMS
 - Development of innovative hermeticity testing methods

- **Microsystem integration with a wafer-scale SiP (System-in-Package) approach**
 - Development performed by **ÁAC** (Sweden).
 - Technology and performance was demonstrated.
 - Reliability needs to be investigated.

- **3D-Stacking for microsystem integration**
 - ESA may soon initiate activities to assess 3D-stacking techniques



Prototype of EADS micropack
Size: 16cm³ (20x20x25 + 25x25x9)
Power Consumption: < 10mW

What's next?

➤ **Present open Invitation to tender related to MEMS :**

❖ **Microwave micromachined filters (ARTES 5)**

- Objective: Design and manufacture Micro-machined membrane filters with multilayer topology, suitable for L/S-band and Ka-band.

❖ **Xenon flow-meter for propellant gauging (ARTES 5)**

- Objective: Design, manufacture and test an EM of a xenon flow meter to be used primarily for accurate gauging of xenon consumption on telecom satellites. – Not restricted to MEMS-based devices.

❖ **MEMS-based Electric Propulsion (General Study)**

- Objectives: Assess the feasibility of a novel MEMS-based Electric Propulsion

→ Check: <http://emits.esa.int/>

- **Intended Invitation to tender related to MEMS technology in the Technology Research Program (TRP), in 2008-2009:**
 - ❖ **Widely-tunable MEMS LC tank for Wideband Oscillators**
 - Objective: develop, manufacture, and test a MEMS LC tank featuring a wide tunability while maintaining a stable Q-factor
 - ❖ **High-Q MEMS resonator for high-performance oscillators**
 - Objective: Develop a MEMS based mechanical resonators, as an alternative to crystal resonators both in oscillators and filters.
 - ❖ **RF MEMS based reconfigurable telecommunication dual reflector antenna**
 - Objective: Investigate the feasibility of using MEMS switches for programmable contoured beams in Ku- and Ka-band dual-reflector telecom antennas
 - ❖ **Accelerometer for IMU feasibility demonstrator**
 - Objectives: Develop an accelerometer demonstrator to be implemented as the accelerometer component of a low-cost IMU for Spacecrafts

→ Check: <http://emits.esa.int/>

- In addition, ESA decided to support a **strawman mission initiative** in order to co-ordinate cross disciplinary technology developments and to introduce microsystems perspective.
- This Technology Research Programme (TRP) initiative, for a total budget of 7M€ over 3 years will support the following developments (presently under implementation).
- These are **precursor development for an in-orbit demonstration of Near Earth Object Micro Explorer (NEOMEx) mission** to be developed under **GSTP/New Pro programmes**

❖ **Strawman Payload**

Microtelescope array space instrument

❖ **System design and Architecture**

Architect of the System-of- μ systems
nanospacecraft

Standard modular microsystems interface

Data handling system design and proof-of-concept

❖ **Attitude and Orbit Control System and Navigation**

Definition and sizing of AOCS (incl. propulsion)

Digital sun sensor on the chip prototyping

❖ **Propulsion**

Medium Δv low-power and voltage μ -thruster

Propellant management and storage module

❖ **Structure**

Integrated harness technology

Multifunctional structures

❖ **Thermal**

Temperature-dependent thermal coatings

Micro phase-change materials

Micro heat management systems

❖ **Communication**

Transmitter Vacuum Electric Power
Amplifier

Receiver low power analog decoder

❖ **Power**

Thin-film Lithium Battery development

Ultra-thin Multijunction GaAs Solar power
generator

❖ **Reliability, manufacture, standardization**

Connectivity and Packaging

Advanced manufacturing method

Reliability and Standardisation

Conclusion

- **Many promising developments on MEMS for Space in Europe**
- Technology is available but mostly still at low maturity for Space
- The “**spin-in**” approach from terrestrial applications can shorten development cycles, however:
 - Space is a small market → Lack of interest from large manufacturers
 - Reliability requirements are different → Non-negligible testing and redesign effort needed
- Efforts are still required to understand and mitigate **MEMS failure mechanisms**
- Efforts are still required on **packaging and integration** of MEMS
- No test standard is available for the Space qualification of MEMS:
 - Define & validate screening, evaluation and qualification procedures
 - In the longer term, write related ESCC specifications

- **More information available on:**



- **6th Round Table on Micro/Nano Technologies for Space (October 2007)**

Presentations available on:

<https://escies.org/ReadArticle?docId=766>

Expected use of MEMS in ESA missions

